# 32-bit Proprietary Microcontrollers

## FR60Lite MB91265A Series

### MB91266A/MB91F267A/MB91F267NA/MB91V265A

#### ■ DESCRIPTION

The MB91265A series is a 32-bit RISC microcontroller designed by Fujitsu for embedded control applications which require high-speed processing.

The CPU is used the FR family\* and the compatibility of FR60Lite.

MB91F267NA loads the C-CAN (1 channel) .

\*: FR, the abbreviation of FUJITSU RISC controller, is a line of products of FUJITSU Limited.

### **■ FEATURES**

- FR60Lite CPU
  - 32-bit RISC, load/store architecture with a five-stage pipeline
  - Maximum operating frequency: 33 MHz (oscillation frequency 4.192 MHz, oscillation frequency 8-multiplier (PLL clock multiplication method)
  - 16-bit fixed length instructions (basic instructions)
  - Execution speed of instructions : 1 instruction per cycle
  - Memory-to-memory transfer, bit handling, barrel shift instructions, etc.: Instructions suitable for embedded applications
  - Function entry/exit instructions, multiple-register load/store instructions: Instructions adapted for C-language
  - Register interlock function : Facilitates coding in assembler.
  - Built-in multiplier with instruction-level support
    - 32-bit multiplication with sign : 5 cycles
    - 16-bit multiplication with sign : 3 cycles
  - Interrupt (PC, PS save): 6 cycles, 16 priority levels
  - · Harvard architecture allowing program access and data access to be executed simultaneously
  - Instruction compatible with FR family

(Continued)

Be sure to refer to the "Check Sheet" for the latest cautions on development.

"Check Sheet" is seen at the following support page

URL: http://www.fujitsu.com/global/services/microelectronics/product/micom/support/index.html

"Check Sheet" lists the minimal requirement items to be checked to prevent problems beforehand in system development.



(Continued)

- Internal peripheral functions
  - Capacity of internal ROM and ROM type

MASK ROM: 64 Kbytes (MB91266A)

Flash ROM: 128 Kbytes (MB91F267A/MB91F267NA)

: 24 Kbytes (evaluation model\*)

- \*: Evaluation model is MB91V265A.
- Capacity of internal RAM: 2 Kbytes (MASK product)/4 Kbytes (Flash memory product)
- A/D converter (sequential comparison type)

Resolution: 8/10 bits: 4 channels  $\times$  1 unit, 7 channels  $\times$  1 unit

Conversion time: 1.2 µs (Minimum conversion time system clock at 33 MHz)

1.35 μs (Minimum conversion time system clock at 20 MHz)

- External interrupt input : 8 channels
- Bit search module (for REALOS)

Function for searching the MSB (upper bit) in each word for the first 1-to-0 inverted bit position

- C-CAN 32MSB: 1 channel (loaded in MB91F267NA only)
- UART (Full-duplex double buffer): 2 channels

Selectable parity On/Off

Asynchronous (start-stop synchronized) or clock-synchronous communications selectable

Internal timer for dedicated baud rate (U-TIMER) on each channel

External clock can be used as transfer clock

Error detection function for parity, frame, and overrun errors

- 8/16-bit PPG timer: 8 channels (at 8-bit) / 4 channels (at 16-bit)
- Timing generator
- 16-bit reload timer: 3 channels (with cascade mode, without output of reload timer 0)
- 16-bit free-run timer: 3 channels
- 16-bit PWC timer: 1 channel
- Input capture: 4 channels (interface with free-run timer)
- Output compare : 6 channels (interface with free-run timer)
- Waveform generator

Various waveforms which are generated by using output compare, 16-bit PPG timer 0, and 16-bit dead timer

· SUM of products macro

RAM : instruction RAM (I-RAM)  $256 \times 16$ -bit coefficient RAM (X-RAM)  $64 \times 16$ -bit variable RAM (Y-RAM)  $64 \times 16$ -bit

Execution of 1 cycle MAC (16-bit × 16-bit + 40 bits)

Operation results are extracted rounded from 40 to 16 bits

• DMAC (DMA Controller) : 5 channels

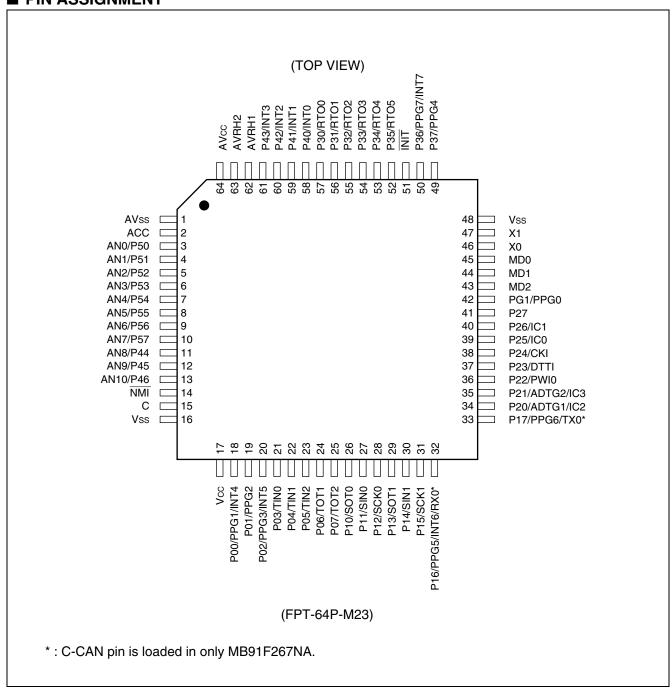
Operation of transfer and activation by internal peripheral interrupts and software

- · Watchdog timer
- Low-power consumption mode

Sleep/stop function

- Package : LQFP-64P
- Technology: CMOS 0.35 μm
- Power supply : 1-power supply (Vcc = 4.0 V to 5.5 V)

### **■ PIN ASSIGNMENT**



### **■ PIN DESCRIPTION**

Pin no.	Pin name	I/O Circuit type*1	Description		
3	AN0	G	Analog input terminal of A/D converter 1.  This function becomes valid when set the corresponding AICR1 register to analog input.		
3	P50	G	General purpose input/output port. This function becomes valid when analog input is set to disabled.		
4	AN1	G	Analog input terminal of A/D converter 1. This function becomes valid when set the corresponding AICR1 register to analog input.		
7	P51	u	General purpose input/output port. This function becomes valid when analog input is set to disabled.		
5	AN2	G	Analog input terminal of A/D converter 1. This function becomes valid when set the corresponding AICR1 register to analog input.		
5	P52	G	General purpose input/output port. This function becomes valid when analog input is set to disabled.		
6	AN3	G	Analog input terminal of A/D converter 1. This function becomes valid when set the corresponding AICR1 register to analog input.		
6	P53	G	General purpose input/output port. This function becomes valid when analog input is set to disabled.		
7	AN4	G	Analog input terminal of A/D converter 2. This function becomes valid when set the corresponding AICR2 register to analog input.		
,	P54		General purpose input/output port. This function becomes valid when analog input is set to disabled.		
8	AN5	G	Analog input terminal of A/D converter 2. This function becomes valid when set the corresponding AICR2 register to analog input.		
0	P55	G	General purpose input/output port. This function becomes valid when analog input is set to disabled.		
0	AN6	G	Analog input terminal of A/D converter 2. This function becomes valid when set the corresponding AICR2 register to analog input.		
9	P56	G	General purpose input/output port. This function becomes valid when analog input is set to disabled.		
10	AN7	G	Analog input terminal of A/D converter 2. This function becomes valid when set the corresponding AICR2 register to analog input.		
10	P57	G	General purpose input/output port. This function becomes valid when analog input is set to disabled.		
11	AN8	G	Analog input terminal of A/D converter 2. This function becomes valid when set the corresponding AICR2 register to analog input.		
11	P44	G	General purpose input/output port. This function becomes valid when analog input is set to disabled.		
10	AN9	C	Analog input terminal of A/D converter 2. This function becomes valid when set the corresponding AICR2 register to analog input.		
12	P45	G 45	General purpose input/output port. This function becomes valid when analog input is set to disabled.		

Pin no.	Pin name	I/O Circuit type*1	Description		
13	AN10	G	Analog input terminal of A/D converter 2. This function becomes valid when set the corresponding AICR2 register to analog input.		
	P46		General purpose input/output port. This function becomes valid when analog input is set to disabled.		
14	NMI	Н	NMI (Non Maskable Interrupt) input terminal.		
	INT4		External interrupt input terminal.  Since this input is used as required while the corresponding external interrupt is enabled, the port output must remain off unless intentionally used.		
18	PPG1	E	Output terminal of PPG timer 1. This function becomes valid when output of PPG timer 1 is set to enabled.		
	P00		General purpose input/output port. This function becomes valid when output of PPG timer 1 and external interrupt input are set to disabled.		
19	PPG2	D	Output terminal of PPG timer 2. This function becomes valid when output of PPG timer 2 is set to enabled.		
19	P01		General purpose input/output port. This function becomes valid when output of PPG timer 2 is set to disabled.		
	INT5		External interrupt input terminal. Since this input is used as required while the corresponding external interrupt is enabled, the port output must remain off unless intentionally used.		
20	PPG3	E	Output terminal of PPG timer 3. This function becomes valid when output of PPG timer 3 is set to enabled.		
	P02		General purpose input/output port. This function becomes valid when output of PPG timer 3 and external interrupt input are set to disabled.		
21	TIN0	-	External trigger input terminal of reload timer 0. Since this input is used as required while the trigger input is enabled, the port output must remain off unless intentionally used.		
21	P03	D	General purpose input/output port. This function becomes valid when external clock input of reload timer 0 is set to disabled.		
22	TIN1	D	External trigger input terminal of reload timer 1. Since this input is used as required while the trigger input is enabled, the port output must remain off unless intentionally used.		
22 –	P04	D	General purpose input/output port. This function becomes valid when external clock input of reload timer 1 is set to disabled.		
23	TIN2	D	External trigger input terminal of reload timer 2. Since this input is used as required while the trigger input is enabled, the port output must remain off unless intentionally used.		
20	P05	0	General purpose input/output port. This function becomes valid when external clock input of reload timer 2 is set to disabled.		

Pin no.	Pin name	I/O Circuit type*1	Description
24	TOT1	D	Output terminal of reload timer 1. This function becomes valid when output of reload timer 1 is set to enabled.
24	P06	D	General purpose input/output port. This function becomes valid when output of reload timer 1 is set to disabled.
25	ТОТ2	D	Output terminal of reload timer 2. This function becomes valid when output of reload timer 2 is set to enabled.
25	P07	D	General purpose input/output port. This function becomes valid when output of reload timer 2 is set to disabled.
26	SOT0	D	UART0 data output terminal. This function becomes valid when data output of UART0 is set to enabled.
20	P10 D		General purpose input/output port. This function becomes valid when data output of UART0 is set to disabled.
27	SIN0	D	UART0 data input terminal. Since this input is used as required while the UART0 input is enabled, the port output must remain off unless intentionally used.
	P11		General purpose input/output port. This function becomes valid when data input of UART0 is set to disabled.
28	SCK0	D	UART0 clock input/output terminal. This function becomes valid when clock output of UART0 is set to enabled.
20	P12		General purpose input/output port. This function becomes valid when clock output of UART0 is set to disabled.
29	SOT1	D	UART1 data output terminal. This function becomes valid when data output of UART1 is set to enabled.
29	P13	D	General purpose input/output port. This function becomes valid when data output of UART1 is set to disabled.
30	SIN1	D	UART1 data input terminal. Since this input is used as required while the UART1 input is enabled, the port output must remain off unless intentionally used.
	P14		General purpose input/output port. This function becomes valid when data input of UART1 is set to disabled.
31	SCK1	D	UART1 clock input/output terminal. This function becomes valid when clock output of UART1 is set to enabled.
31	P15	P15	General purpose input/output port. This function becomes valid when clock output of UART1 is set to disabled.

Pin no.	Pin name	I/O Circuit type*1	Description		
	INT6		External interrupt input terminal. Since this input is used as required while the corresponding external interrupt is enabled, the port output must remain off unless intentionally used.		
	PPG5		Output terminal of PPG timer 5. This function becomes valid when output of PPG timer 5 is set to enabled.		
32	RX0	E	RX0 input terminal of C-CAN0 (MB91F267NA only ) . Since this input is used as required while the RX0 input is enabled, port output must remain off unless intentionally used.		
	P16		General purpose input/output port.  This function becomes valid when output of PPG timer 5 and RX0 input*2 of C-CAN0 are set to disabled.		
	PPG6		Output terminal of PPG timer 6. This function becomes valid when output of PPG timer 6 is set to enabled.		
33	TX0	D	TX0 output terminal of C-CAN0 (only MB91F267NA) . This function becomes valid when TX0 output of C-CAN0 is set to enabled.		
	P17		General purpose input/output port.  This function becomes valid when output of PPG timer 6 and TX0 output*2 of C-CAN0 are set to disabled.		
	ADTG1	D	External trigger input terminal of A/D converter 1. Since this input is used as required while it selects as A/D activation trigger cause, the port output must remain off unless intentionally used.		
34	IC2		Trigger input terminal of input capture 2.  The port can serve as an input when set for input with the setting of the input capture trigger input. When the port is used for input capture input, this input is used as required. The port output must therefore remain off unless intentionally used.		
	P20		General purpose input/output port.  This function becomes valid when the setting of the external trigger input of A/D converter 1 or the setting of the input capture trigger input is set to disabled.		
	ADTG2	D	External trigger input terminal of A/D converter 2. Since this input is used as required while it selects as A/D activation trigger cause, the port output must remain off unless intentionally used.		
35	IC3		Trigger input terminal of input capture 3.  The port can serve as an input when set for input with the setting of the input capture trigger input. When the port is used for input capture input, this input is used as required. The port output must therefore remain off unless intentionally used.		
	P21		General purpose input/output port.  This function becomes valid when the setting of the external trigger input of A/D converter 2 or the setting of the input capture trigger input is set to disabled.		
36	PWI0	D	Pulse width counter input of PWC timer 0 This function becomes valid when pulse width counter input of PWC timer 0 is set to enabled.		
30	P22	U	General purpose input/output port. This function becomes valid when pulse width counter input of PWC timer 0 is set to disabled.		

Pin no.	Pin name	I/O Circuit type*1	Description	
37	DTTI	D	Control input signal of multi-function timer waveform generator output RTO0 to RTO5. This function becomes valid when DTTI input is set to enabled.	
37	P23	ם	General purpose input/output port. This function becomes valid when input of DTTI is set to disabled.	
38	CKI	D	External clock input terminal of free-run timer.  Since this input is used as required while the port is used for external clock input terminal of free-run timer, the port output must remain off unless intentionally used.	
00	P24	J	General purpose input/output port. This function becomes valid when external clock input of free-run timer is set to disabled.	
39	IC0	D	Trigger input terminal of input capture 0.  The port can serve as an input when set for input with the setting of the trigger input of input capture 0. When the port is used for input capture input, this input is used as required. The port output must therefore remain off unless intentionally used.	
	P25		General purpose input/output port. This function becomes valid when trigger input of input capture 0 is set to disabled.	
40	IC1	D	Trigger input terminal of input capture 1.  The port can serve as an input when set for input with the setting of the trigger input of input capture 1. When the port is used for input capture input, this input is used as required. The port output must therefore remain off unless intentionally used.	
	P26		General purpose input/output port.  This function becomes valid when trigger input of input capture 1 is set to disabled.	
41	P27	D	General purpose input/output port.	
42	PPG0		Output terminal of PPG timer 0. This function becomes valid when output of PPG timer 0 is set to enabled.	
42	PG1	D	General purpose input/output port. This function becomes valid when output of PPG timer 0 is set to disabled.	
43	MD2	H, K	Mode terminal 2. Setting this pin determines the basic operation mode. Connect to Vcc or Vss. The circuit type of flash memory models is K.	
44	MD1	H, K	Mode terminal 1. Setting this pin determines the basic operation mode. Connect to Vcc or Vss. The circuit type of flash memory models is K.	
45	MD0	Н	Mode terminal 0. Setting this pin determines the basic operation mode. Connect to Vcc or Vss.	
46	X0	Α	Clock (oscillation) input terminal.	
47	X1	Α	Clock (oscillation) output terminal.	
49	PPG4	D	Output terminal of PPG timer 4. This function becomes valid when output of PPG timer 4 is set to enabled.	
43	P37	D	General purpose input/output port. This function becomes valid when output of PPG timer 4 is set to disabled.	

Pin no.	Pin name	I/O Circuit type*1	Description		
	INT7		External interrupt input terminal. Since this input is used as required while the corresponding external interrupt is enabled, the port output must remain off unless intentionally used.		
50	PPG7	Е	Output terminal of PPG timer 7. This function becomes valid when output of PPG timer 7 is set to enabled.		
	P36		General purpose input/output port. This function becomes valid when output of PPG timer 7 is set to disabled.		
51	TINI	I	External reset input terminal.		
52	RTO5	J	Waveform generator output terminal of multi-function timer. This terminal outputs waveform set at the waveform generator. This function becomes valid when waveform generator output of multi-function timer is set to enabled.		
	P35		General purpose input/output port. This function becomes valid when output of waveform generator is set to disabled.		
53	RTO4	J	Waveform generator output terminal of multi-function timer. This terminal outputs waveform set at the waveform generator. This function becomes valid when waveform generator output of multi-function timer is set to enabled.		
	P34		General purpose input/output port. This function becomes valid when output of waveform generator is set to disabled.		
54	RTO3	J	Waveform generator output terminal of multi-function timer. This terminal outputs waveform set at the waveform generator. This function becomes valid when waveform generator output of multi-function timer is set to enabled.		
	P33		General purpose input/output port. This function becomes valid when output of waveform generator is set to disabled.		
55	RTO2	J	Waveform generator output terminal of multi-function timer. This terminal outputs waveform set at the waveform generator. This function becomes valid when waveform generator output of multi-function timer is set to enabled.		
	P32		General purpose input/output port. This function becomes valid when output of waveform generator is set to disabled.		
56	RTO1	J	Waveform generator output terminal of multi-function timer. This terminal outputs waveform set at the waveform generator. This function becomes valid when waveform generator output of multi-function timer is set to enabled.		
	P31		General purpose input/output port. This function becomes valid when output of waveform generator is set to disabled.		
57	RTO0	J	Waveform generator output terminal of multi-function timer. This terminal outputs waveform set at the waveform generator. This function becomes valid when waveform generator output of multi-function timer is set to enabled.		
	P30		General purpose input/output port. This function becomes valid when output of waveform generator is set to disabled.		
58	INT0	E	External interrupt input terminal. Since this input is used as required while the corresponding external interrupt is enabled, the port output must remain off unless intentionally used.		
	P40	P40	General purpose input/output port. This function becomes valid when external interrupt input is set to disabled.		

(Continued)

Pin no.	Pin name	I/O Circuit type*1	Description					
59	INT1 E		External interrupt input terminal. Since this input is used as required while the corresponding external interrupt is enabled, the port output must remain off unless intentionally used.					
	P41		General purpose input/output port. This function becomes valid when external interrupt input is set to disabled.					
60	INT2	E	External interrupt input terminal. Since this input is used as required while the corresponding external interrupt is enabled, the port output must remain off unless intentionally used.					
	P42		General purpose input/output port. This function becomes valid when external interrupt input is set to disabled.					
61	INT3	Е	External interrupt input terminal.  Since this input is used as required while the corresponding external interrupt is enabled, the port output must remain off unless intentionally used.					
	P43		General purpose input/output port. This function becomes valid when external interrupt input is set to disabled.					

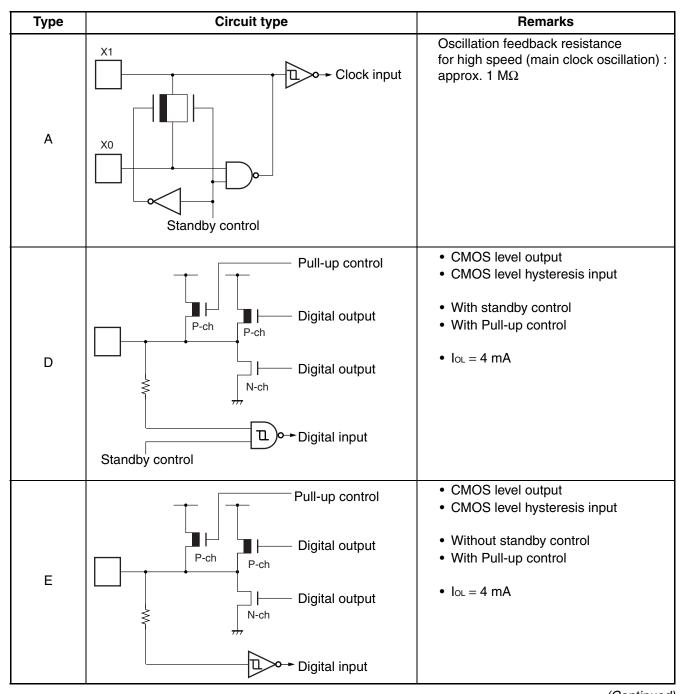
<sup>\*1 :</sup> For the I/O circuit type, refer to " ■ I/O CIRCUIT TYPE "

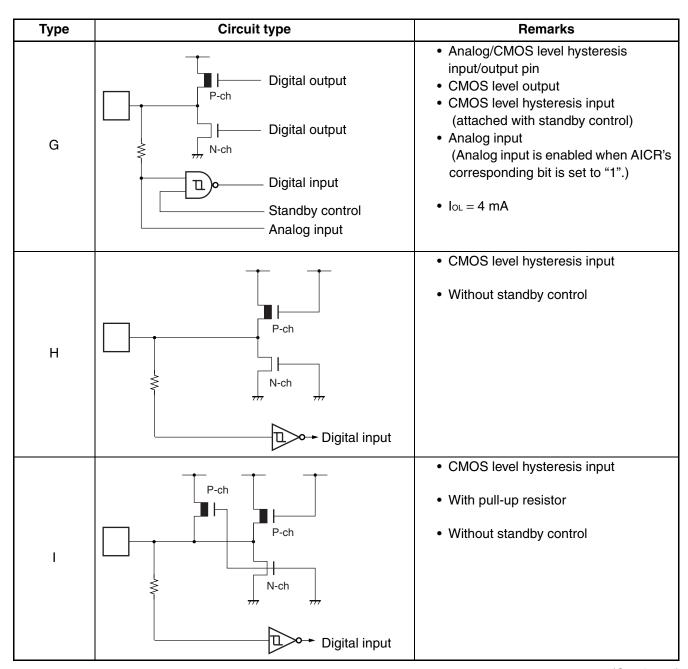
• Power supply and GND pins

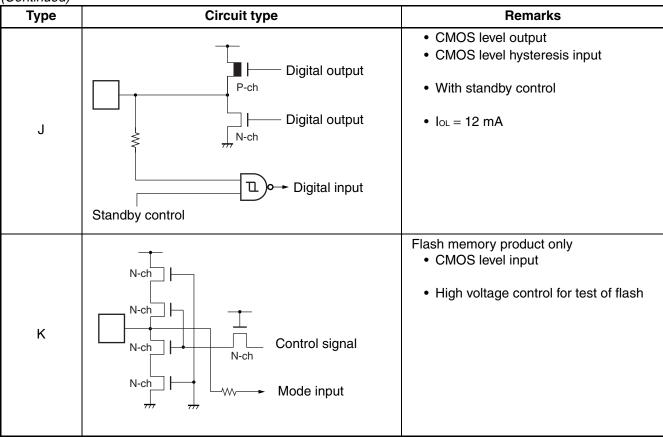
Pin no.	Pin name	Description
16, 48	Vss	GND pins. Apply equal potential to all of the pins.
17	Vcc	Power supply pin. Apply equal potential to all of the pins.
64	AVcc	Analog power supply pin for A/D converter.
63	AVRH2	Analog reference power supply pin for A/D converter 2.
62	AVRH1	Analog reference power supply pin for A/D converter 1.
1	AVss	Analog GND pin for A/D converter.
15	С	Condenser connection pin for internal regulator.
2	ACC	Condenser connection pin for analog.

<sup>\*2 :</sup> C-CAN is set in only MB91F267NA.

### **■ I/O CIRCUIT TYPE**







### **■ HANDLING DEVICES**

#### **Preventing Latch-up**

Latch-up may occur in a CMOS IC if a voltage greater than Vcc pin or less than Vss pin is applied to an input or output pin or if an above-rating voltage is applied between Vcc and Vss pins.

A latch-up, if it occurs, significantly increases the power supply current and may cause thermal destruction of an element. When you use a CMOS IC, be very careful not to exceed the absolute maximum rating.

#### **Treatment of Unused Input Pins**

Do not leave an unused input pin open, since it may cause a malfunction. Handle by, for example, using a pull-up or pull-down resistor.

#### **About Power Supply Pins**

In products with multiple  $V_{\text{CC}}$  or  $V_{\text{SS}}$  pins, the pins of the same potential are internally connected in the device to avoid abnormal operations including latch-up. However, you must connect the pins to external power supply and a ground line to lower the electro-magnetic emission level, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total output current rating.

Moreover, connect the current supply source with the Vcc and Vss pins of this device at the low impedance.

It is also advisable to connect a ceramic bypass capacitor of approximately 0.1  $\mu$ F between  $V_{\text{CC}}$  and  $V_{\text{SS}}$  pins near this device.

### **About Crystal Oscillator Circuit**

Noise near the X0 and X1 pins may cause the device to malfunction. Design the printed circuit board so that X0 and X1 pins the crystal oscillator (or ceramic oscillator) , and the bypass capacitor to ground are located as close to the device as possible.

It is strongly recommended to design the PC board artwork with the X0 and X1 pins surrounded by ground plane because stable operation can be expected with such a layout.

Please ask the crystal maker to evaluate the oscillational characteristics of the crystal and this device.

#### About Mode Pins (MD0 to MD2)

These pins should be connected directly to Vcc or Vss pins.

To prevent the device erroneously switching to test mode due to noise, design the printed circuit board such that the distance between the mode pins and  $V_{CC}$  or  $V_{SS}$  pins is as short as possible and the connection impedance is low.

#### **Operation at Start-up**

Be sure to execute setting initialized reset (INIT) with INIT pin immediately after start-up.

Also, in order to provide the oscillation stabilization wait time for the oscillation circuit immediately after start-up, hold the "L" level input to the  $\overline{\text{INIT}}$  pin for the required stabilization wait time (For INIT via the  $\overline{\text{INIT}}$  pin, the oscillation stabilization wait time setting is initialized to the minimum value) .

### Order of power turning ON/OFF

Use the following procedure for turning the power on or off.

Note that, even if the A/D converter is not used, keep the following pins connected with the level as described below.

AVcc = Vcc level

 $AV_{SS} = V_{SS}$  level

- When Powering ON: Vcc→AVcc→AVRH
- When Powering OFF : AVRH→AVcc→Vcc

### **About Oscillation Input at Power On**

When turning the power on, maintain clock input until the device is released from the oscillation stabilization wait state.

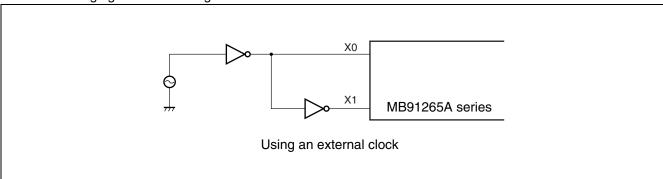
### Caution for operation during PLL clock mode

On this microcontroller, if in case the crystal oscillator breaks off or an external reference clock input stops while the PLL clock mode is selected, a self-oscillator circuit contained in the PLL may continue its operation at its self-running frequency. However, Fujitsu will not guarantee results of operations if such failure occurs.

#### **External clock**

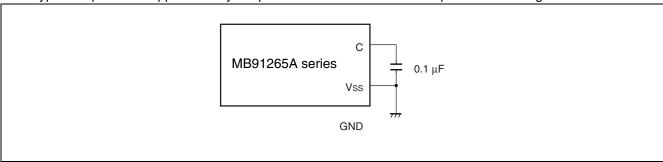
When external clock is selected, the opposite phase clock to X0 pin must be supplied to X1 pin simultaneously. If the STOP mode (oscillation stop mode) is used simultaneously, the X1 pin is stopped with the "H" output. So, when STOP mode is specified, approximately 1  $k\Omega$  of resistance should be added externally to avoid the collision of output.

The following figure shows using an external clock.



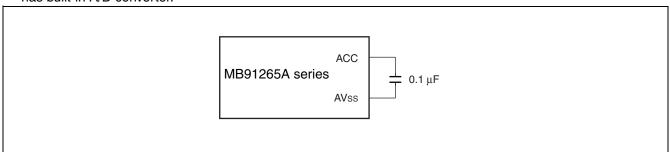
#### C pin

A bypass capacitor of approximately 0.1 µF should be connected the C pin for built-in regulator.



### **ACC** pin

A capacitor of approximately 0.1  $\mu$ F should be inserted between the ACC pin and the AVss pin as this product has built-in A/D converter.



### **Clock Control Block**

Input the "L" signal to the INIT pin to assure the clock oscillation stabilization wait time.

#### **Switch Shared Port Function**

To switch between the use as a port and the use as a dedicated pin, use the port function register (PFR) .

#### **Low Power Consumption Mode**

To enter the standby mode, use the synchronous standby mode (set with the SYNCS bit as bit 8 in the TBCR : timebase counter control register) and be sure to use the following sequence

(LDI #value\_of\_standby, R0) : value\_of\_standby is write data to STCR. #\_STCR, R12) (LDI : \_STCR is address (481H) of STCR. STB R0, @R12 : Writing to standby control register (STCR) @R12, R0 : STCR read for synchronous standby **LDUB LDUB** @R12, R0 : Dummy re-read of STCR NOP : NOP × 5 for arrangement of timing NOP NOP NOP NOP

In addition, please set I flag, ILM, and ICR to diverge to the interruption handler that is the return factor after the standby returns.

- Please do not do the following when the monitor debugger is used.
- Break point setting for above instruction lines
- Step execution for above instruction lines

### Notes on the PS register

As the PS register is processed by some instructions in advance, exception handling below may cause the interrupt handling routine to break when the debugger is used or the display contents of flags in the PS register to be updated.

As the microcontroller is designed to carry out reprocessing correctly upon returning from such an EIT event, it performs operations before and after the EIT as specified in either case.

- The following operations may be performed when the instruction immediately followed by a DIVOU/DIVOS instruction is (a) acceptance of a user interrupt, (b) single-stepped, or (c) breaks in response to a data event or emulator menu:
  - 1) The D0 and D1 flags are updated in advance.
  - 2) An EIT handling routine (user interrupt or emulator) is executed.
  - 3) Upon returning from the EIT, the DIVOU/DIVOS instruction is executed, and the D0 and D1 flags are updated to the same values as in 1).
- The following operations are performed when the ORCCR/STILM/MOVRi and PS instructions are executed to allow the interrupt.
  - 1) The PS register is updated in advance.
  - 2) An EIT handling routine (user interrupt) is executed.
  - 3) Upon returning from the EIT, the above instructions are executed, and the PS register is updated to the same value as in 1).

### **Watchdog Timer**

The watchdog timer built in this model monitors a program that it defers a reset within a certain period of time. The watchdog timer resets the CPU if the program runs out of controls, preventing the reset defer function from being executed. Once the function of the watchdog timer is enabled, therefore, the watchdog timer keeps on operating programs until it resets the CPU.

As an exception, the watchdog timer defers a reset automatically under the condition in which the CPU stops program execution.

For those conditions to which this exception applies, refer to " NOTE ON DEBUGGER".

#### **■ NOTE ON DEBUGGER**

#### Step execution of RETI command

If an interrupt occurs frequently during step execution, the corresponding interrupt handling routine is executed repeatedly after step execution.

This will prevent the main routine and low-interrupt-level programs from being executed.

Do not execute step of RETI instruction for escape.

Disable the corresponding interrupt and execute debugger when the corresponding interrupt handling routine no longer needs debugging.

### • Operand break

Do not apply a data event break to access to the area containing the address of a system stack pointer.

#### Execution in an unused area of flash memory

Accidentally executing an instruction in an unused area of flash memory (with data placed at 0xFFFF) prevents breaks from being accepted.

To prevent this, the code event address mask function of the debugger should be used to cause a break when accessing an instruction in an unused area.

#### Power-on debugging

All of the following three conditions must be satisfied when the power supply is turned off by power-on debugging.

- (1) The time for the user power to fall from 0.9  $V_{CC}$  to 0.5  $V_{CC}$  is 25  $\mu s$  or longer. Note: In a dual-power system,  $V_{CC}$  indicates the external I/O power supply voltage.
- (2) CPU operating frequency must be higher than 1 MHz.
- (3) During execution of user program

### • Interrupt handler for NMI request (tool)

Add the following program to the interrupt handler to prevent the device from malfunctioning in case the factor flag to be set only in response to a break request from the ICE is set, for example, by an adverse effect of noise to the DSU pin while the ICE is not connected. Enable to use the ICE while adding this program.

#### Additional location

Next interrupt handler

Interrupt source : NMI request (tool)

Interrupt number : #13 (decimal), 0D (hexadecimal)

Offset : 3C8H

Address TBR is default : 000FFFC8H

#### Additional program

STM (R0, R1)

LDI #B00н, R0; : B00н is the address of DSU break factor register.

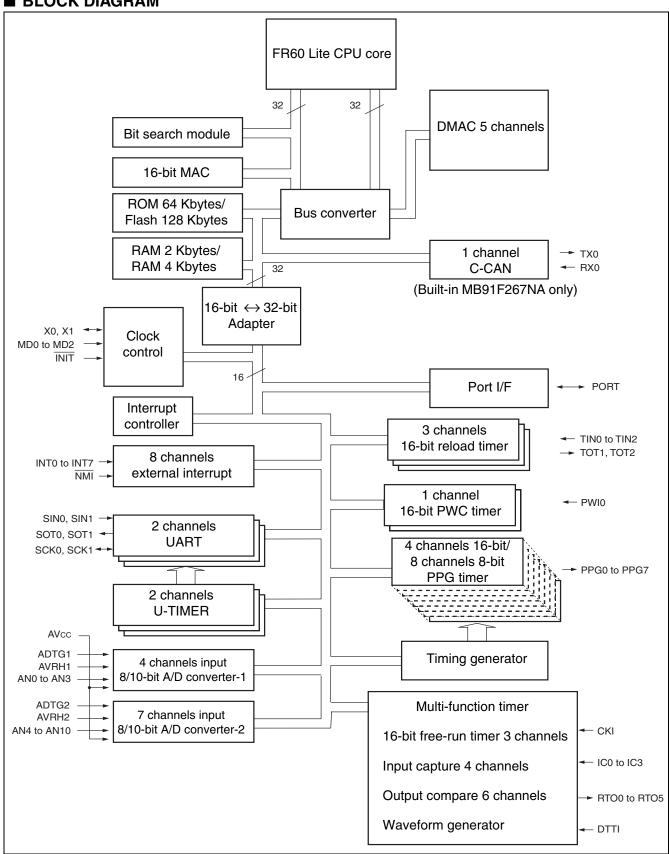
LDI #0, R1

STB R1, @R0 : Clear the break factor register.

LDM (R0, R1)

RETI

### **■ BLOCK DIAGRAM**



### **■ MEMORY SPACE**

### 1. Memory space

The FR family has 4 Gbytes of logical address space (2<sup>32</sup> addresses) available to the CPU by linear access.

### Direct Addressing Areas

The following address space areas are used as I/O areas.

These areas are called direct addressing areas, in which the address of an operand can be specified directly during an instruction.

The size of directly addressable areas depends on the data size to be being accessed as follows.

ightarrow byte data access : 000 $_{\rm H}$  to 0FF $_{\rm H}$  ightarrow half word data access : 000 $_{\rm H}$  to 1FF $_{\rm H}$  ightarrow word data access : 000 $_{\rm H}$  to 3FF $_{\rm H}$ 

### 2. Memory Map

MB91F267A/	/MB91F267NA		MB91266A		
	Single chip mode			Single chip mod	le
0000 0000н	I/O	Direct addressing area	0000 0000н	I/O	Direct addressing area
0000 0400H	I/O	Refer to ■ I/O MAP		I/O	Refer to ■ I/O MAP
0001 0000н	Access disallowed		0001 0000н	Access disallowed	
0003 F000н 0004 0000н	Internal RAM 4 Kbytes		0003 F800н 0004 0000н	Internal RAM 2 Kbytes	
0004 0000H	Access disallowed		0004 0000H	Access disallowed	
000E 0000H	Internal ROM 128 Kbytes		000F 0000н	Internal ROM 64 Kbytes	
0010 0000н	Access disallowed		0010 0000н	Access disallowed	
FFFF FFFF <sub>H</sub>			FFFF FFFF <sub>H</sub>		

### **■ MODE SETTINGS**

The FR family uses mode pins (MD2 to MD0) and a mode data to set the operation mode.

• Mode Pins

The MD2 to MD0 pins specify how the mode vector fetch and reset vector fetch is performed.

Setting is prohibited other than that shown in the following table.

M	Mode Pins		Mode name	Reset vector	Remarks
MD2	MD1	MD0	access area		nemarks
0	0	0	Internal ROM mode vector	Internal	
0	0	1	External ROM mode vector	External	Not supported by this model.

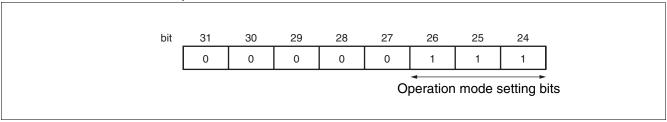
#### Mode data

Data written to the internal mode register (MODR) by a mode vector fetch is called mode data.

After an operation mode has been set in the mode register, the device operates in the operation mode.

The mode data is set by all reset source. User programs cannot set data to the mode register.

Details of mode data description



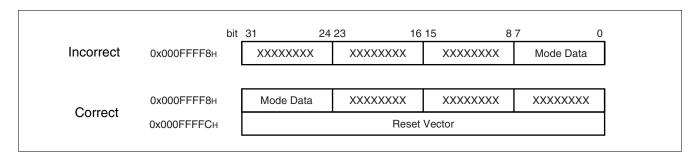
Bit31 to bit24 are all reserved bits.

Be sure to set this bit to "00000111".

Operation is not guaranteed when any value other than "00000111" is set.

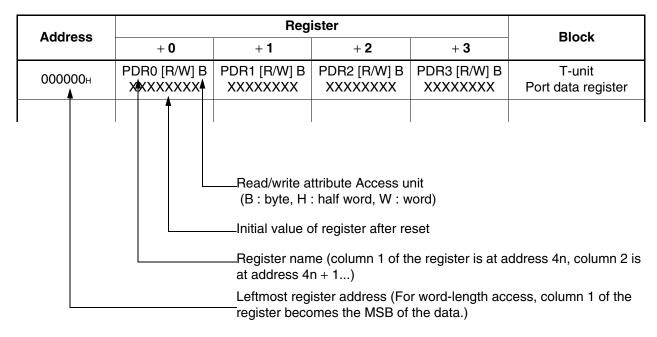
Note: Mode data set in the mode vector must be placed as byte data at 0x000FFFF8H.

Use the highest byte from bit31 to bit24 for placement as the FR family uses the big endian for byte endian.



### ■ I/O MAP

[How to read the table]



Note: Initial values of register bits are represented as follows:

" 1 " : Initial Value " 1 " " 0 " : Initial Value " 0 "

" X ": Initial Value " undefined"

" - " : No physical register at this location

Access is barred with an undefined data access attribute.

A ddwooo		Block				
Address	+ 0	+ 1	+ 2	+ 3	Block	
000000н	PDR0 [R/W] B, H, W XXXXXXXX	PDR1 [R/W] B, H, W XXXXXXXX	PDR2 [R/W] B, H, W XXXXXXXX	PDR3 [R/W] B, H, W XXXXXXXX		
000004н	PDR4 [R/W] B, H, W -XXXXXXX	PDR5 [R/W] B, H, W XXXXXXXX	_	_	Port data	
000008н	_	_	_			
00000Сн	_	_	_	_		
000010н	PDRG [R/W] B, H, W	_	_	_		
000014н to 00003Сн		_			Reserved	
000040н	EIRR0 [R/W] B, H, W 00000000	ENIR0 [R/W] B, H, W 00000000		W] B, H, W 00000000	External interrupt (INT0 to INT7)	
000044н	DICR [R/W] B, H, W HRCL [R/W, R] B, H, W0		Delay interrupt/ Hold request			
000048н	TMRLR0 XXXXXXXX	R] H, W XXXXXXXX	Reload			
00004Сн	-	-	TMCSR0 [R/W, R] B, H, W 00000 00000000		timer 0	
000050н	TMRLR1 XXXXXXXX		TMR1 [R] H, W XXXXXXXX XXXXXXX		Reload	
000054н	-	-		TMCSR1 [R/W, R] B, H, W 00000 00000000		
000058н	TMRLR2 XXXXXXXX		TMR2 [R] H, W XXXXXXXX XXXXXXX		Reload	
00005Сн	_	-		W, R] B, H, W 00000000	timer 2	
000060н	SSR0 [R/W, R] B, H, W 00001000	SIDR0 [R]/SODR0[W] B, H, W XXXXXXXX	SCR0 [R/W] B, H, W 00000100	SMR0 [R/W, W] B, H, W 000-0-	UART0	
000064н	UTIM0 [R] H / 00000000		DRCL0 [W] B	UTIMC0 [R/W] B 000001	U-TIMER 0	
000068н	SSR1 [R/W, R] B, H, W 00001000	SIDR1 [R]/SODR1[W] B, H, W XXXXXXXX	SCR1 [R/W] B, H, W 00000100	SMR1 [R/W] B, H, W 000-0-	UART1	
00006Сн	UTIM1 [R] H / 00000000		DRCL1 [W] B	UTIMC1 [R/W] B 000001	U-TIMER 1	
000070н to 00007Сн	_	_	_	_	Reserved	

A dduooo	Register								
Address	+ 0	+ 1	+ 2	+ 3	Block				
000080н	ADCH1 [R/W] B, H, W XXXX0XX0	ADMD1 [R/W] B, H, W 00001111	ADCD11 [R] B, H, W XXXXXXXX	ADCD10 [R] B, H, W XXXXXXXX	A/D				
000084н	ADCS1 [R/W, W] B, H, W 00000X00			_	converter 1/ AICR1				
000088н	ADCH2 [R/W] B, H, W XXXX0XX0	ADMD2 [R/W] B, H, W 00001111	ADCD21 [R] B, H, W XXXXXXXX	ADCD20 [R] B, H, W XXXXXXXX	A/D converter 2/				
00008Сн	ADCS2 [R/W, W] B, H, W 00000X00	_	AICR2 [R/W] B, H, W -0000000	_	AICR2				
000090н	OCCPBH0, OCCPBL0[W] / OCCPBH1, OCCPBL1[W] / OCCPH0, OCCPL0[R] H, W O0000000 00000000 00000000 000000000 0000								
000094н	OCCPH2, OCC	OCCPBH2, OCCPBL2[W] / OCCPBH3, OCCPBL3[W] / OCCPH2, OCCPL2 [R] H, W OCCPH3, OCCPL3 [R] H, W OCCPH3, OC							
000098н	OCCPH4, OCC	OCCPBH4, OCCPBL4[W] /       OCCPBH5, OCCPBL5[W] /         OCCPH4, OCCPL4 [R] H, W       OCCPH5, OCCPL5 [R] H, W         00000000 00000000       00000000 00000000		CPL5 [R] H, W	output compare				
00009Сн	OCSH1 [R/W] B, H, W X1100000	OCSL0 [R/W] B, H, W 00001100	OCSH3 [R/W] B, H, W X1100000	OCSL2 [R/W] B, H, W 00001100					
0000А0н	OCSH5 [R/W] B, H, W X1100000	OCSL4 [R/W] B, H, W 00001100	OCMOD [R/W] B, H, W XX000000	_					
0000А4н	CPCLRBH0, CI CPCLRH0, CPC 111111111	CLRL0[R] H, W		TL0 [R/W] H, W 0 00000000	16-bit free-run				
0000А8н	TCCSH0 [R/W] B, H, W 00000000	TCCSL0 [R/W] B, H, W 01000000	_	ADTRGC [R/W] B, H, W XXXX0000	timer 0				
0000АСн	IPCPH0, IPCF XXXXXXXX X			CPL1 [R] H, W XXXXXXXXX					
0000ВОн	IPCPH2, IPCF XXXXXXXX			CPL3 [R] H, W XXXXXXXX	16-bit input capture				
0000В4н	PICSH01 [W] B, H, W 00000000	PICSL01 [R/W] B, H, W 00000000	ICSH23 [R] B, H, W XXXXXX00	ICSL23 [R/W]B, H, W 00000000	- Japiano				
0000В8н	_	_	_	_	Reserved				
0000ВСн	TMRRH0, TMRF XXXXXXXX			RRL1 [R/W] H, W					
0000С0н	TMRRH2, TMRRL2 [R/W] H, W								
0000С4н	DTCR0 [R/W] B, H, W 00000000	DTCR1 [R/W] B, H, W 00000000	DTCR2 [R/W] B, H, W 00000000	generator					
0000С8н	_	SIGCR1 [R/W] B, H, W 00000000	_	SIGCR2 [R/W] B, H, W XXXXXXX1					

A alalys a a	Register					
Address	+ 0	+ 1	+ 2	+ 3	Block	
0000ССн	_			[R/W] H, W 00000000		
0000D0н		[R/W] H, W 00000000	ADCOMPC2 [R/W] B, H, W XX0000XX	ADCOMPC1 [R/W] B, H, W XXXXX00X	A/D COMP	
0000Д4н			_	_		
0000D8н	_	_	_	_	Reserved	
0000DС <sub>Н</sub>	_	<u>—</u>	_	_		
0000Е0н	_	W, R] B, H, W 00000000		[R] H, W 00000000		
0000Е4н	_	_	_	_	16-bit PWC timer	
0000Е8н	_	PDIVR0 [R/W] B, H, W XXXXX000	_	_		
0000ЕСн	_	_	_	_		
0000F0н	_	_	_	_		
000F4н to 000FСн	_	_	_	_	Reserved	
000100н	PRLH0 [R/W] B, H, W XXXXXXXX	PRLL0 [R/W] B, H, W XXXXXXXX	PRLH1 [R/W] B, H, W XXXXXXXX	PRLL1 [R/W] B, H, W XXXXXXXX		
000104н	PRLH2 [R/W] B, H, W XXXXXXXX	PRLL2 [R/W] B, H, W XXXXXXXX	PRLH3 [R/W] B, H, W XXXXXXXX	PRLL3 [R/W] B, H, W XXXXXXXX		
000108н	PPGC0 [R/W] B, H, W 00000000	PPGC1 [R/W] B, H, W 00000000	PPGC2 [R/W] B, H, W 00000000	PPGC3 [R/W] B, H, W 00000000	8/16-bit PPG timer	
00010Сн	PRLH4 [R/W] B, H, W XXXXXXXX	PRLL4 [R/W] B, H, W XXXXXXXX	PRLH5 [R/W] B, H, W XXXXXXXX	PRLL5 [R/W] B, H, W XXXXXXXX	0 to 7	
000110н	PRLH6 [R/W] B, H, W XXXXXXXX	PRLL6 [R/W] B, H, W XXXXXXXX	PRLH7 [R/W] B, H, W XXXXXXXX	PRLL7 [R/W] B, H, W XXXXXXXX		
000114н	PPGC4 [R/W] B, H, W 00000000	PPGC5 [R/W] B, H, W 00000000	PPGC6 [R/W] B, H, W 00000000	PPGC7 [R/W] B, H, W 00000000		
000118н to 00012Сн	_	_	_	_	Reserved	
000130н	TRG [R/W] B H W		_	GATEC [R/W] B, H, W XXXXXX00	8/16-bit	
000134н	REVC [R/W] B, H, W 00000000		_	_	PPG timer 0 to 7	
000138н to 000140н	_	_	_	_	Reserved	

۸ ماما <i>د</i> م	Register							
Address	+ 0	+ 1	+ 2	+ 3	Block			
000144н	TTCR0 [R/W] B, H, W 00000000	_	_	TSTPR0 [R] B, H, W 00000000				
000148н	COMP0 [R/W] B, H, W 00000000	COMP2 [R/W] B, H, W 00000000	COMP4 [R/W] B, H, W 00000000	COMP6 [R/W] B, H, W 00000000	Timing generator			
00014Сн	_	_	_	_				
000150н	_	_	_	_				
000154н	CPCLRBH1, CP CPCLRH1, CPC 111111111 1	LRL1 [R] H, W		TL1 [R/W] H, W 00000000	16-bit free-run			
000158н	TCCSH1 [R/W] B, H, W 00000000	TCCSL1 [R/W] B, H, W 01000000	_	_	timer 1			
00015Сн	CPCLRBH2, CP CPCLRH2, CPC 11111111 1	LRL2 [R] H, W	TCDTH2, TCD 00000000	TL2 [R/W] H, W 00000000	16-bit free-run			
000160н	TCCSH2 [R/W] B, H, W 00000000	TCCSL2 [R/W] B, H, W 01000000	_	_	timer 2			
000164н	_	_	_	_	Reserved			
000168н	_	FSR2 [R/W] B, H, W 00000000	FSR1 [R/W] B, H, W 0000	FSR0 [R/W] B, H, W 00000000	FRT selector			
00016Сн to 0001А4н	<del>-</del>							
0001А8н	CANPRE [R, R/W] B, H, W 00000000	_	_	_	C-CAN*1 prescaler			
0001ACн to 0001FCн	_							
000200н		DMACA0 [R/W 00000000 0000XXXX XX						
000204н		DMACB0 [R/V 00000000 00000000 XX						
000208н	(	DMACA1 [R/W 00000000 0000XXXX XX						
00020Сн		DMACB1 [R/V 00000000 00000000 XX	•					
000210н		DMACA2 [R/W 00000000 0000XXXX XX	= ' ' '		DMAC			
000214н		DMACB2 [R/V 00000000 00000000 XXX	•		DIVIAO			
000218н	DMACA3 [R/W] B, H, W *2 00000000 0000XXXX XXXXXXXX XXXXXXXX							
00021Сн		DMACB3 [R/V 00000000 00000000 XXX						
000220н		DMACA4 [R/W 00000000 0000XXXX XX	= ' ' '					
000224н		DMACB4 [R/V 00000000 00000000 XXX	- · · · · · · · · · · · · · · · · · · ·					

A -1 -1	Register						
Address	+ 0	+ 1	+ 2	+ 3	Block		
000228н to 00023Сн	<u> </u>						
000240н			R [R/W] B XXXXXXXX XXXXXXX	(	DMAC		
000244н to 00024Сн	_						
000250н	_	_	_	<del>-</del>	Reserved		
000254н to 000398н	_						
00039Сн	_	_	_	<del>-</del>			
0003А0н	DSP-PC [R/W] XXXXXXXX	DSP-CSR [R/W, R, W] 00000000		Y [R/W] X XXXXXXXX			
0003А4н		OTO [R] XXXXXXXX		OT1 [R] ( XXXXXXXX			
0003А8н		OT2 [R] XXXXXXXX		OT3 [R] XXXXXXXX	16 bit MAC		
0003АСн	_	_	_	_			
0003В0н		OT4 [R] XXXXXXXX		OT5 [R] ( XXXXXXXX			
0003В4н	DSP-OT6[R] DSP-OT7 [R] XXXXXXXX XXXXXXXX XXXXXXXX						
0003В8н	_	_					
0003BCн to 0003ECн		-	_		Reserved		
0003F0н			( XXXXXXXX XXXXXXX	X			
0003F4н			[R/W] W X XXXXXXXX XXXXXXX	X	Bit search		
0003F8н	RSDC IWI W						
0003FСн			RR [R] ( XXXXXXXX XXXXXXX	X			
000400н	DDR0 [R/W] B, H, W 00000000	DDR1 [R/W] B, H, W 00000000	DDR2 [R/W] B, H, W 00000000	DDR3 [R/W] B, H, W 00000000			
000404н	DDR4 [R/W] B, H, W -0000000	DDR5 [R/W] B, H, W 00000000	_	_	Data		
000408н	_	_		_	direction register		
00040Сн	_	_		_	3 - 1.5.		
000410н	DDRG [R/W] B, H, W	_	_	_			

A -l -l		Reg	jister		Block			
Address	+0 +1 +2 +3							
000414н to 00041Сн	_							
00041Сн	PFR0 [R/W] B, H, W	PFR1 [R/W] B, H, W 0-0-00-0	_	_				
000424н	_	_	_	_	Port			
000428н	_	_	_	_	function			
00042Сн	_	_	_	_	register			
000430н	_	_	_	PTFR0 [R/W] B, H, W 00000000				
000434н to 00043Сн		-	_		Reserved			
000440н	ICR00 [R/W, R] B, H, W	ICR01 [R/W, R] B, H, W1111	ICR02 [R/W, R] B, H, W	ICR03 [R/W, R] B, H, W				
000444н	ICR04 [R/W, R] B, H, W	ICR05 [R/W, R] B, H, W 1111	ICR06 [R/W, R] B, H, W	ICR07 [R/W, R] B, H, W				
000448н	ICR08 [R/W, R] B, H, W	ICR09 [R/W, R] B, H, W	ICR10 [R/W, R] B, H, W	ICR11 [R/W, R] B, H, W				
00044Сн	ICR12 [R/W, R] B, H, W	ICR13 [R/W, R] B, H, W	ICR14 [R/W, R] B, H, W	ICR15 [R/W, R] B, H, W				
000450н	ICR16 [R/W, R] B, H, W	ICR17 [R/W, R] B, H, W	ICR18 [R/W, R] B, H, W	ICR19 [R/W, R] B, H, W				
000454н	ICR20 [R/W, R] B, H, W	ICR21 [R/W, R] B, H, W	ICR22 [R/W, R] B, H, W	ICR23 [R/W, R] B, H, W	Interrupt			
000458н	ICR24 [R/W, R] B, H, W	ICR25 [R/W, R] B, H, W	ICR26 [R/W, R] B, H, W	ICR27 [R/W, R] B, H, W	control unit			
00045Сн	ICR28 [R/W, R] B, H, W	ICR29 [R/W, R] B, H, W	ICR30 [R/W, R] B, H, W	ICR31 [R/W, R] B, H, W				
000460н	ICR32 [R/W, R] B, H, W	ICR33 [R/W, R] B, H, W	ICR34 [R/W, R] B, H, W	ICR35 [R/W, R] B, H, W				
000464н	ICR36 [R/W, R] B, H, W	ICR37 [R/W, R] B, H, W	ICR38 [R/W, R] B, H, W	ICR39 [R/W, R] B, H, W				
000468н	ICR40 [R/W, R] B, H, W	ICR41 [R/W, R] B, H, W	ICR42 [R/W, R] B, H, W	ICR43 [R/W, R] B, H, W				
00046Сн	ICR44 [R/W, R] B, H, W	ICR45 [R/W, R] B, H, W	ICR46 [R/W, R] B, H, W	ICR47 [R/W, R] B, H, W				
000470н to 00047Сн		-	_		Reserved			

	Register						
Address	+ 0	+ 1	+ 2	+ 3	Block		
000480н	RSRR [R/W] B, H, W 10000000	STCR [R/W] B, H, W 00110011	TBCR [R/W] B, H, W 00XXXX00	CTBR [W] B, H, W XXXXXXXX			
000484н	CLKR [R/W] B, H, W 00000000	WPR [W] B, H, W XXXXXXXX	DIVR0 [R/W] B, H, W 00000011	DIVR1 [R/W] B, H, W 00000000	Clock control		
000488н							
00048Сн	_		_	_			
000490н	_	_	<u>—</u>	_			
000494н to 0005FCн			_		Reserved		
000600н	PCR0 [R/W] B, H, W 00000000	PCR1 [R/W] B, H, W 00000000	PCR2 [R/W] B, H, W 00000000	PCR3 [R/W] B, H, W 00			
000604н	PCR4 [R/W] B, H, W 0000	_	_	_	Pull-up		
000608н	<u> </u>	_	_	_	Control Unit		
00060Сн	_	<del>_</del>	_	_	_		
000610н	PCRG [R/W] B, H, W	_	_				
000614н to 00063Сн 000640н to 000FFCн	<u>—</u> н						
001000н			0 [R/W] W XXXXXXXX XXXXXX	X			
001004н			0 [R/W] W XXXXXXXX XXXXXX	x			
001008н			1 [R/W] W K XXXXXXXX XXXXXXX	X			
00100Сн			1 [R/W] W X XXXXXXXX XXXXXXX	X			
001010н		XXXXXXXX XXXXXXX	2 [R/W] W K XXXXXXXX XXXXXXX	X	DMAC		
001014н	DMADA2 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX						
001018н	DMASA3 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX						
00101Сн			3 [R/W] W K XXXXXXXX XXXXXXX	X			
001020н		DMASA4 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX					
001024н			4 [R/W] W XXXXXXXX XXXXXX	X			

Address	Register							
Address	+ 0	+ 3	Block					
001028н					Reserved			
to 006FFC <sub>H</sub>	<del>_</del>							
007000н	FLCR [R/W] B 01101000							
007004н	FLWC [R/W] B 00000011	_	_	_	Flash			
007008н	_	_	- I laon					
00700Сн	_	_	_	_				
007010н	_	_	_	_				
007014н to			_		Reserved			
00BFFCн								
00С000н to 00С07Сн			cient RAM) [R/W]					
00С080н to 00С0FСн			ble RAM) [R/W] : 16-bit		16 bit MAC			
00С100н to 00С2FСн								
00С300н								
to 00FFFC <sub>H</sub>		Reserved						
020000н	CTRLR0 00000000		STATR0 00000000	[R, R/W] 00000000				
020004н	ERRCN 00000000		BTR0 [I 00100011					
020008н	INTR 00000000			TESTR0 [R, R/W] 00000000 X0000000				
02000Сн	BRPER0 00000000		_	_				
020010н	IF1CREQ0 00000000		IF1CMSKI 00000000	C-CAN*1				
020014н	IF1MSK20 11111111		IF1MSK 11111111	10 [R/W] 11111111	O-CAIN '			
020018н	IF1ARB2 00000000			10 [R/W] 00000000				
02001Сн	IF1MCTR( 00000000		_	_				
020020н	IF1DTA <sup>-</sup> 00000000		IF1DTA2 00000000					
020024н	IF1DTB <sup>-</sup> 00000000		IF1DTB2 00000000	20 [R/W] 00000000				

(Continued)

Address	Register					
Address	+ 0	+ 1	+ 2	+ 3	- Block	
020030н	R	eserved (IF1 data mirro	r, little endian byte orderi	ng)		
020040н		0 [R, R/W] 00000000		0 [R, R/W] 00000000		
020044н		0 [R, R/W] 11111111		10 [R/W] 11111111		
020048н		20 [R/W] 00000000		10 [R/W] 00000000		
02004Сн		0 [R, R/W] 00000000	_	_		
020050н	IF2DTA10 [R/W] 00000000 00000000			IF2DTA20 [R/W] 00000000 00000000		
020054н	IF2DTB10 [R/W] 00000000 00000000		IF2DTB20 [R/W] 00000000 00000000			
020060н	R	eserved (IF2 data mirro	r, little endian byte ordering)		C-CAN*1	
020080н		R20 [R] 00000000	TREQR10 [R] 00000000 00000000			
020084н		Reserved (>321	28 Message buffer)			
020090н		T20 [R] 00000000		T10 [R] 00000000		
020094н		Reserved (>321	28 Message buffer)			
0200А0н		D20 [R] 00000000		D10 [R] 00000000		
0200А4н	Reserved (>32128 Message buffer)					
0200В0н		AL20 [R] 00000000		MESVAL10 [R] 00000000 00000000		
0200В4н		Reserved (>321	28 Message buffer)			

<sup>\*1 :</sup> C-CAN is loaded in only MB91F267NA.

Notes: • The initial value of FLWC (7004H) is "00010011B" on EVA tool. Writing "00000011B" on the evaluation model has no effect on its operation.

- Do not execute Read Modify Write instructions on registers having a write-only bit.
- Data is undefined in reserved or (-) area.

<sup>\*2:</sup> The lower 16 bits (DTC15 to DTC0) of DMACA0 to DMACA4 cannot be accessed in bytes.

### **■ INTERRUPT VECTOR**

	Interrup	number	la ta uu sa t		TDD defects
Interrupt source	Decimal	Hexa- decimal	Interrupt level	Offset	TBR default address
Reset	0	00	_	3FСн	000FFFCн
Mode vector	1	01	_	3F8н	000FFF8 <sub>H</sub>
System reserved	2	02	_	3F4н	000FFFF4н
System reserved	3	03	_	3F0н	000FFF0н
System reserved	4	04	_	3ЕСн	000FFFECн
System reserved	5	05	_	3Е8н	000FFFE8н
System reserved	6	06	_	3Е4н	000FFFE4н
Coprocessor absent trap	7	07	_	3Е0н	000FFE0н
Coprocessor error trap	8	08	_	3DСн	000FFFDCн
INTE instruction	9	09	_	3D8н	000FFFD8н
System reserved	10	0A	_	3D4н	000FFFD4н
System reserved	11	0B	_	3D0н	000FFFD0н
Step trace trap	12	0C	_	3ССн	000FFFCCн
NMI request (tool)	13	0D	_	3С8н	000FFFC8н
Undefined instruction exception	14	0E	_	3С4н	000FFFC4н
NMI request	15	0F	15 (Fн) fixed	3С0н	000FFFC0н
External interrupt 0	16	10	ICR00	3ВСн	000FFFBCн
External interrupt 1	17	11	ICR01	3В8н	000FFFB8н
External interrupt 2	18	12	ICR02	3В4н	000FFFB4н
External interrupt 3	19	13	ICR03	3В0н	000FFFB0н
External interrupt 4	20	14	ICR04	ЗАСн	000FFFACн
External interrupt 5	21	15	ICR05	3А8н	000FFFA8н
External interrupt 6/C-CAN wake up*	22	16	ICR06	3А4н	000FFFA4н
External interrupt 7	23	17	ICR07	3А0н	000FFFA0н
Reload timer 0	24	18	ICR08	39Сн	000FFF9Сн
Reload timer 1	25	19	ICR09	398н	000FFF98н
Reload timer 2	26	1A	ICR10	394н	000FFF94н
UART0(Reception completed)	27	1B	ICR11	390н	000FFF90н
UART0 (RX completed)	28	1C	ICR12	38Сн	000FFF8Сн
DTTI	29	1D	ICR13	388н	000FFF88н
DMAC0 (end, error)	30	1E	ICR14	384н	000FFF84н
DMAC1 (end, error)	31	1F	ICR15	380н	000FFF80н
DMAC2/DMAC3/DMAC4 (end, error)	32	20	ICR16	37Сн	000FFF7Сн

	Interrup	number	Interviet		TRD defeult
Interrupt source	Decimal	Hexa- decimal	Interrupt level	Offset	TBR default address
UART1(Reception completed)	33	21	ICR17	378н	000FFF78н
UART1 (RX completed)	34	22	ICR18	374н	000FFF74н
C-CAN0*	35	23	ICR19	370н	000FFF70н
System reserved	36	24	ICR20	36Сн	000FFF6Сн
16-bit MAC	37	25	ICR21	368н	000FFF68н
PPG0/PPG1	38	26	ICR22	364н	000FFF64н
PPG2/PPG3	39	27	ICR23	360н	000FFF60н
PPG4/PPG5/PPG6/PPG7	40	28	ICR24	35Сн	000FFF5Сн
System reserved	41	29	ICR25	358н	000FFF58н
Waveform0/1/2 (underflow)	42	2A	ICR26	354н	000FFF54н
Free-run timer 1 (compare clear)	43	2B	ICR27	350н	000FFF50н
Free-run timer 1 (zero detection)	44	2C	ICR28	34Сн	000FFF4Сн
Free-run timer 2 (compare clear)	45	2D	ICR29	348н	000FFF48н
Free-run timer 2 (zero detection)	46	2E	ICR30	344н	000FFF44н
Timebase timer overflow	47	2F	ICR31	340н	000FFF40н
Free-run timer 0 (compare clear)	48	30	ICR32	33Сн	000FFF3Сн
Free-run timer 0 (zero detection)	49	31	ICR33	338н	000FFF38н
System reserved	50	32	ICR34	334н	000FFF34н
A/D converter 1	51	33	ICR35	330н	000FFF30н
A/D converter 2	52	34	ICR36	32Сн	000FFF2Сн
PWC0 (measurement completed)	53	35	ICR37	328н	000FFF28н
System reserved	54	36	ICR38	324н	000FFF24н
PWC0 (overflow)	55	37	ICR39	320н	000FFF20н
System reserved	56	38	ICR40	31Сн	000FFF1Сн
ICU0 (capture)	57	39	ICR41	318н	000FFF18н
ICU1 (capture)	58	ЗА	ICR42	314н	000FFF14н
ICU2/3 (capture)	59	3B	ICR43	310н	000FFF10н
OCU0/1 (match)	60	3C	ICR44	30Сн	000FFF0Сн
OCU2/3 (match)	61	3D	ICR45	308н	000FFF08н
OCU4/5 (match)	62	3E	ICR46	304н	000FFF04н
Delay interrupt source bit	63	3F	ICR47	300н	000FFF00н
System reserved (Used by REALOS)	64	40		2FCн	000FFEFCн
System reserved (Used by REALOS)	65	41		2F8н	000FFEF8н

	Interrupt number				TBR default	
Interrupt source	Decimal	Hexa- decimal	Interrupt level	Offset	address	
System reserved	66	42	_	2F4н	000FFEF4н	
System reserved	67	43	_	2F0н	000FFEF0н	
System reserved	68	44	_	2ЕСн	000FFEECн	
System reserved	69	45		2E8 <sub>H</sub>	000FFEE8н	
System reserved	70	46	_	2Е4н	000FFEE4н	
System reserved	71	47	_	2Е0н	000FFEE0н	
System reserved	72	48	_	2DC <sub>H</sub>	000FFEDCн	
System reserved	73	49	_	2D8н	000FFED8н	
System reserved	74	4A	_	2D4н	000FFED4н	
System reserved	75	4B	_	2D0н	000FFED0н	
System reserved	76	4C	_	2ССн	000FFECCн	
System reserved	77	4D	_	2С8н	000FFEC8н	
System reserved	78	4E		2С4н	000FFEC4н	
System reserved	79	4F	_	2С0н	000FFEC0н	
Used by INT instruction	80 to 255	50 to FF	_	2ВСн to 000н	000FFEBCн to 000FFC00н	

<sup>\*:</sup> C-CAN interrupt is only loaded in MB91F267NA.

### **■ PIN STATUS IN EACH CPU STATE**

Terms used as the status of pins mean as follows.

- Input enabled

  Indicates that the input function
  - Indicates that the input function can be used.
- Input 0 fixed Indicates that the input level has been internally fixed to be 0 to prevent leakage when the input is released.
- Output Hi-Z
- Output is maintained.

Indicates the output in the output state existing immediately before this mode is established. If the device enters this mode with an internal output peripheral operating or while serving as an output port, the output is performed by the internal peripheral or the port output is maintained, respectively.

State existing immediately before is maintained.
 When the device serves for output or input immediately before entering this mode, the device maintains the output or is ready for the input, respectively.

• List of pin status (single chip mode)

Pin no.	Pin name Function		At initializing		At sleep	At Stop mode	
Pili lio.	Pili lialile	Function	INIT = L*1	INIT = H*2	mode	Hi-Z = 0	Hi-Z = 1
3 to 10	P50 to P57	AN0 to AN7	Output Hi-Z/	Output Hi-Z/	Retention of	Retention	0
11 to 13	P44 to P46	AN8 to AN10	Input disabled	Input enabled	the immedi- ately prior state	of the immediately prior state	Output Hi-Z/ Input 0 fixed
14	NMI	NMI	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled
18	P00	PPG1/INT4			Chabled	Chabled	Chabled
19	P01	PPG2			Retention of the immediately prior state	Retention of the immediately prior state	Output Hi-Z/ Input 0 fixed
20	P02	PPG3/INT5			Input enabled	Input enabled	Input enabled
21 to 23	P03 to P05	TIN0 to TIN2					
24, 25	P06, P07	TOT1, TOT2	Output Hi-Z/	Output Hi-Z/			
26	P10	SOT0	Input disabled	Input enabled	Retention	Retention	
27	P11	SIN0	uisabieu	enabled	of the	of the	Output Hi-Z/
28	P12	SCK0			immediately	immediately	Input 0 fixed
29	P13	SOT1			prior state	prior state	
30	P14	SIN1					
31	P15	SCK1					
32	P16	PPG5/INT6/ RX0*3			Input enabled	Input enabled	Input enabled

#### (Continued)

Pin no.	Pin name	Function	At initi	alizing	At sleep	At Stop	mode
Pili lio.	Fill Hallie	Function	INIT = L*1	INIT = H*2	mode	Hi-Z = 0	Hi-Z = 1
33	P17	PPG6/TX0*3					
34	P20	ADTG1/IC2					
35	P21	ADTG2/IC3					
36	P22	PWI0					
37	P23	DTTI			Retention	Retention	<b>.</b>
38	P24	CKI		Output Hi-Z/	of the immediately prior state	of the immediately prior state	Output Hi-Z/ Input 0 fixed
39	P25	IC0					input o nixou
40	P26	IC1	Output Hi-Z/				
41	P27	General port	Input disabled	Input enabled			
42	PG1	PPG0	disabica	Chabica			
49	P37	PPG4					
50	P36	PPG7/INT7			Input enabled	Input enabled	Input enabled
52 to 57	P35 to P30	RTO5 to RTO0			Retention of the immediately prior state	Retention of the immediately prior state	Output Hi-Z/ Input 0 fixed
58 to 61	P40 to P43	INT0 to INT3			Input enabled	Input enabled	Input enabled

<sup>\*1 :</sup>  $\overline{INIT}$  = L : Indicates the pin status with  $\overline{INIT}$  remaining at the "L" level.

<sup>\*2 :</sup>  $\overline{\text{INIT}} = \text{H}$  : Indicates the pin status existing immediately after  $\overline{\text{INIT}}$  transition from "L" to "H" level.

<sup>\*3:</sup> C-CAN terminal is only loaded in MB91F267NA.

#### **■ ELECTRICAL CHARACTERISTICS**

#### 1. Absolute Maximum Ratings

Parameter	Symbol	Ra	ting	Unit	Remarks
Farameter	Symbol	Min	Max	Oilit	nemarks
Power supply voltage*1	Vcc	Vss - 0.5	Vss + 6.0	V	
Analog power supply voltage*1	AVcc	Vss - 0.5	Vss + 6.0	V	*2
Analog reference voltage*1	AVRHn*6	Vss - 0.5	Vss + 6.0	V	*2
Input voltage*1	Vı	Vss - 0.3	Vcc + 0.3	V	
Analog pin input voltage*1	VIA	Vss - 0.3	AVcc + 0.3	V	
Output voltage*1	Vo	Vss - 0.3	Vcc + 0.3	V	
"L" level maximum output current	lol	_	10	mA	*3
"L" level average output current	lolav	_	8	mA	*4
"L" level total maximum output current	ΣΙοι	_	60	mA	
"L" level total average output current	ΣΙοιαν	_	30	mA	*5
"H" level maximum output current	Іон	_	- 10	mA	*3
"H" level average output current	Іонач	_	- 4	mA	*4
"H" level total maximum output current	ΣІон	_	- 30	mA	
"H" level total average output current	ΣΙομαν	_	- 12	mA	*5
Power consumption	Po	_	600	mW	
Operating temperature	Ta	- 40	+ 105	°C	At single chip operating
Storage temperature	Tstg	- 55	+ 125	°C	

<sup>\*1 :</sup> The parameter is based on  $V_{SS} = AV_{SS} = 0 \text{ V}.$ 

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

<sup>\*2 :</sup> Be careful not to exceed  $V_{CC} + 0.3 \text{ V}$ , for example, when the power is turned on. Be careful not to let  $AV_{CC}$  exceed  $V_{CC}$ , for example, when the power is turned on.

<sup>\*3:</sup> The maximum output current is the peak value for a single pin.

<sup>\*4 :</sup> The average output current is the average current for a single pin over a period of 100 ms.

<sup>\*5 :</sup> The total average output current is the average current for all pins over a period of 100 ms.

<sup>\*6:</sup> AVRHn = AVRH1, AVRH2

#### 2. Recommended Operating Conditions

(Vss = AVss = 0 V)

Parameter	Symbol	Value		Unit	Remarks
raiailletei	Syllibol	Min	Max	Oill	nemarks
Power supply voltage	Vcc	4.0	5.5	V	At normal operating
Analog power supply voltage	AVcc	Vss + 4.0	Vss + 5.5	٧	
Analog reference voltage	AVRH1	AVss	AVcc	V	For A/D converter 1
Analog reference voltage	AVRH2	AVss	AVcc	V	For A/D converter 2
Operating temperature	Ta	<b>- 40</b>	+ 105	°C	At single chip operating

Note: Upon power up, it takes approx. 100  $\mu$ s for stabilization of internal power supply after the Vcc power supply is stabilized. Keep applying "L" to  $\overline{\text{INIT}}$  signal during that period.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

#### 3. DC Characteristics

 $(V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}, V_{SS} = AV_{SS} = 0 \text{ V})$ 

Parameter	Symbol	Pin	Conditions		Value		Unit	Remarks
Parameter	Syllibol	PIII	Conditions	Min	Тур	Max	Offic	nemarks
"H" level input voltage	VIHS	Hysteresis input pin	_	Vcc×0.8	_	Vcc + 0.3	V	
"L" level input voltage	VILS	Hysteresis input pin	_	Vss - 0.3	_	Vss×0.2	٧	
"H" level output	Vон	Other than P30 to P35	$V_{CC} = 5.0 \text{ V},$ $I_{OH} = 4.0 \text{ mA}$	Vcc - 0.5	_	_	٧	
voltage	V <sub>OH2</sub>	P30 to P35	$V_{CC} = 5.0 \text{ V},$ $I_{OH} = 8.0 \text{ mA}$	Vcc - 0.7	_	_	٧	
"L" level output	Vol	Other than P30 to P35	Vcc = 5.0 V, loL = 4.0 mA	_	_	0.4	٧	
voltage	V <sub>OL2</sub>	P30 to P35	Vcc = 5.0 V, loL = 12 mA	_	_	0.6	٧	
Input leak current	lu	_	Vcc = 5.0 V, Vss < V <sub>I</sub> < Vcc	- 5	_	+ 5	μΑ	
Pull-up resistance	Rpull	INIT, Pull-up pin	_	_	50	_	kΩ	
	Icc	Vcc	Vcc = 5.0  V, 33  MHz	_	90	100	mA	
Power supply	Iccs	Vcc	Vcc = 5.0  V, 33  MHz	_	60	80	mA	At SLEEP
current	Іссн	Vcc	Vcc = 5.0 V, Ta = +25 °C	_	300	_	μΑ	At STOP
Input capacitance	Cin	Other than Vcc, Vss, AVcc, AVss, AVRH1, AVRH2	_	_	5	15	pF	

#### 4. Flash Memory Write/Erase Characteristics

Parameter	Conditions		Value			Remarks	
raiailletei	Conditions	Min	Тур	Max	Unit	nemarks	
Sector erase time (4 Kbytes sector)	$Ta = +25 ^{\circ}C,$ $Vcc = 5.0 ^{\circ}V$		0.2	0.5	s	Not including time for internal writing before deletion.	
Byte write time	$Ta = +25 ^{\circ}C,$ $Vcc = 5.0 ^{\circ}V$		32	3600	μs	Not including system-level overhead time.	
Erase/write cycle	_	10000	—	_	cycle		
Flash memory data retention time	Average Ta = + 85 °C	20		_	year	*	

 $<sup>^{\</sup>star}$  : This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at + 85  $^{\circ}\text{C})$  .

#### 5. AC Characteristics

#### (1) Clock Timing Ratings

$$(Vcc = 4.0 V to 5.5 V, Vss = AVss = 0 V)$$

Parameter	Symbol	Pin	Conditions		Value		Unit	Remarks
raiailletei	Symbol	FIII	Conditions	Min	Тур	Max	Oilit	nemarks
Clock frequency	fc	X0 X1		3.6*2		12	MHz	For using the PLL within the self-oscilla-
Clock cycle time	<b>t</b> c	X0 X1		83.3	ı	278*2	ns	tion enabled range, set the multiplier for the internal clock not to let the operating frequency exceed 33 MHz.
Input clock pulse width	Pwh PwL	X0	_	100	_	_	ns	The standard of the duty ratio is 40 % to 60 %.
Input clock rising, falling time	tcf tcr	X0	_	_	_	5	ns	At external clock
Internal operating	<b>f</b> CP		When 4.125 MHz is	2.06*1	_	33	MHz	CPU
clock frequency	<b>f</b> CPP		input as the X0 clock frequency and ×8	2.06*1	_	33	MHz	Peripheral
Internal operating	<b>t</b> cp		multiplication is set	30.3	_	485*1	ns	CPU
clock cycle time	<b>t</b> CPP	— for the PLL of the		30.3	_	485*1	ns	Peripheral

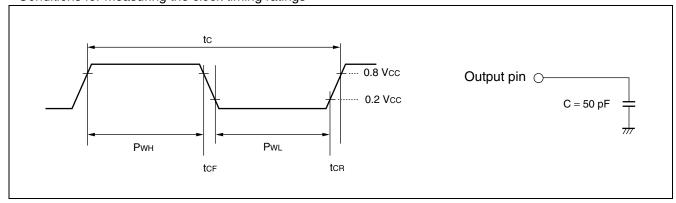
<sup>\*1 :</sup> The values assume a gear cycle of 1/16.

\*2: When the PLL is used, the lower-limit frequency of the input clock to the X0 and X1 pins determines depending on the PLL multiplication.

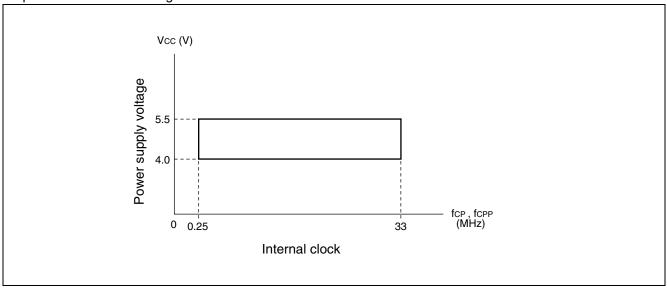
At  $\times$  1 multiplication : more than 8 MHz

At  $\times$  2 to  $\times$  8 multiplication : more than 4 MHz

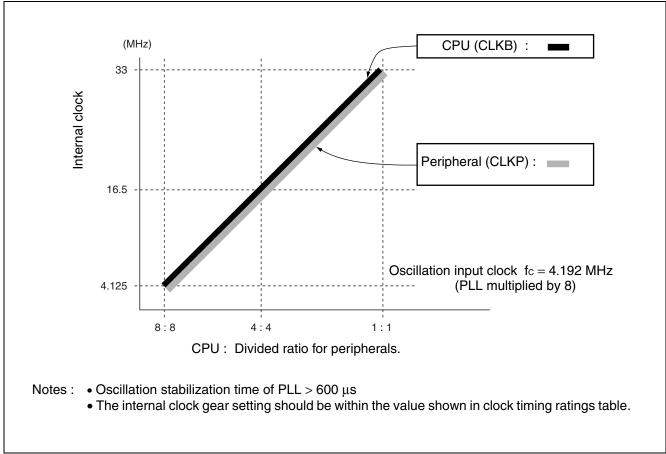
• Conditions for measuring the clock timing ratings



• Operation Assurance Range



• Internal clock setting range

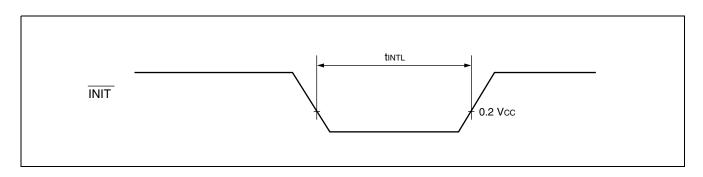


#### (2) Reset Input Ratings

(Vcc = 4.0 V to 5.5 V, Vss = AVss = 0 V)

Parameter	Sym-	Pin	Condi- Value		/alue		Remarks
Parameter	bol		tions	Min	Max	Unit	nemarks
INIT input time (at power-on and STOP mode)	tintl	INIT		Oscillation time of oscillator $+ tc \times 10$	_	ns	*
INIT input time (other than the above)	LINIL	IINII	_	tc × 10	_	ns	

 $<sup>^*</sup>$ : After the power is stable, L level is kept inputting to  $\overline{\text{INIT}}$  for the duration of approximately 100  $\mu s$  until the internal power is stabilized.



#### (3) UART Timing

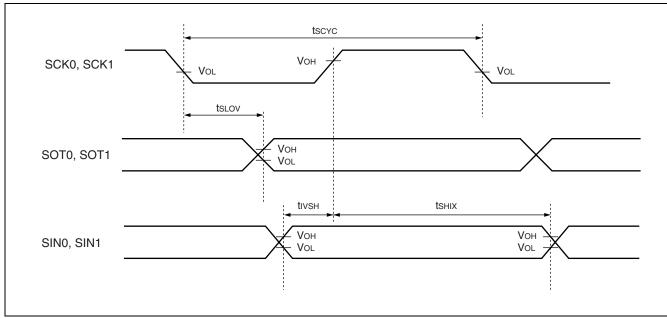
(Vcc = 4.0 V to 5.5 V, Vss = AVss = 0 V)

Parameter	Symbol	Pin	Conditions	Va	lue	Unit
Parameter	Syllibol	FIII	Conditions	Min	Max	Offic
Serial clock cycle time	tscyc	SCK0, SCK1		8 tcycp	_	ns
$SCK \downarrow   o   SOT  delay  time$	tsLOV	SCK0, SCK1, SOT0, SOT1	Internal shift	- 80	+ 80	ns
Valid SIN → SCK ↑	tıvsн	SCK0, SCK1, SIN0, SIN1	clock mode	100	_	ns
$SCK \uparrow \rightarrow valid SIN hold time$	tsнıx	SCK0, SCK1, SIN0, SIN1		60	_	ns
Serial clock "H" pulse width	<b>t</b> shsl	SCK0, SCK1		4 tcycp		ns
Serial clock "L" pulse width	<b>t</b> slsh	SCK0, SCK1		4 tcycp		ns
$SCK \downarrow \to SOT$ delay time	tsLov	SCK0, SCK1, SOT0, SOT1	External shift	_	150	ns
Valid SIN → SCK ↑	tıvsн	SCK0, SCK1, SIN0, SIN1	clock mode	60	_	ns
$SCK \uparrow \rightarrow valid SIN hold time$	tsнıх	SCK0, SCK1, SIN0, SIN1		60	_	ns

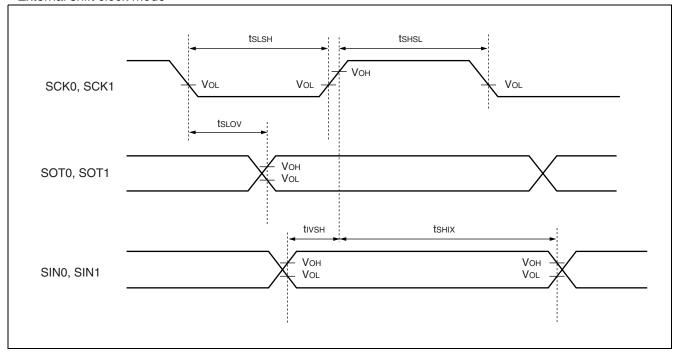
Notes: • The above ratings are the values for clock synchronous mode.

<sup>•</sup> tcycp indicates the peripheral clock cycle time.

#### • Internal shift clock mode



#### • External shift clock mode

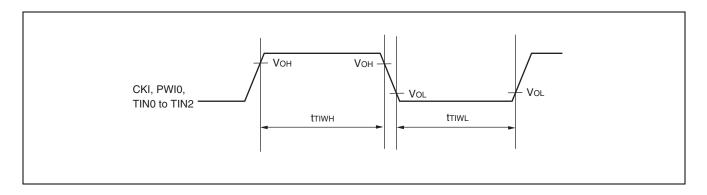


#### (4) Free-run Timer Clock, PWC Input, and Reload Timer Trigger Timing

 $(V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}, V_{SS} = AV_{SS} = 0 \text{ V})$ 

Parameter	Symbol Pin		Conditions	Va	Unit		
Farameter	Symbol	FIII	Conditions	Min	Max		
Input pulse width	tтıwн tтıwL	CKI, PWI0, TIN0 to TIN2	_	4 tcycp	_	ns	

Note: tcycp indicates the peripheral clock cycle time.

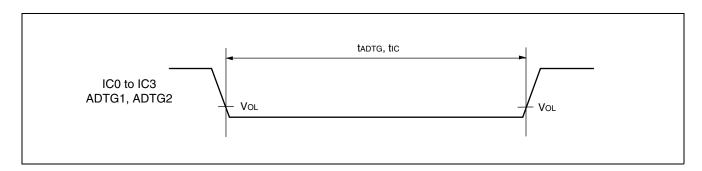


#### (5) Trigger Input Timing

$$(V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}, V_{SS} = AV_{SS} = 0 \text{ V})$$

Parameter	Symbol Pin		Conditions	Va	Unit	
Parameter			Conditions	Min	Max	
Input capture trigger input	tic	IC0 to IC3	_	5 tcycp	_	ns
A/D activation trigger input	<b>t</b> adtg	ADTG1, ADTG2	_	5 tcycp	_	ns

Note: tcycp indicates the peripheral clock cycle time.



#### 6. Electrical Characteristics for the A/D Converter

(Vcc = AVcc = 5.0 V, Vss = AVss = 0 V)

Parameter	Sym-	Pin		Value	,	Unit	nit Remarks	
Parameter	bol	PIII	Min	Тур	Max	Oilit	nemarks	
Resolution	_		_	_	10	bit		
Total error*1	_	_	- 4		+ 4	LSB		
Linearity error*1	_	_	- 3.5		+ 3.5	LSB		
Differential linearity error*1		_	- 3	_	+ 3	LSB	At AVRHn*4 = 5.0 V	
Zero transition voltage*1	Vот	AN0 to AN10	AVss – 3.5LSB	AVss + 0.5LSB	AVss + 4.5LSB	٧	7 (C)	
Full transition voltage*1	V <sub>FST</sub>	AN0 to AN10	AVRH – 5.5LSB	AVRH – 1.5LSB	AVRH + 2.5LSB	٧		
Conversion time	_		1.2*2	_	_	μs		
Analog port Input current	Iain	AN0 to AN10	_	_	10	μА		
Analog input voltage	Vain	AN0 to AN10	AVss	_	AVRH	V		
Reference voltage	_	AVRHn*4	AVss	_	AVcc	V		
Analog power supply	lΑ		_	2	_	mA	Per 1 unit	
current (analog + digital)	<b>I</b> AH*3	AVcc	_	_	100	μА	Per 1 unit	
Reference power supply current (between AVRH and	lR	AVRHn*4	_	1	_	mA	Per 1 unit AVRHn* $^4$ = 5.0 V, at AVss = 0 V	
AVss)	I <sub>RH</sub> *3		_	_	100	μА	Per 1 unit at STOP	
Analog input capacitance	_	_	_	10	_	pF		
Inter-channel disparity	_	AN0 to AN10		_	4	LSB		

<sup>\*1 :</sup> Measured in the CPU sleep state

Note : The above does not guarantee the inter-unit accuracy. Set the output impedance of the external circuit  $\leq 2~k\Omega$ .

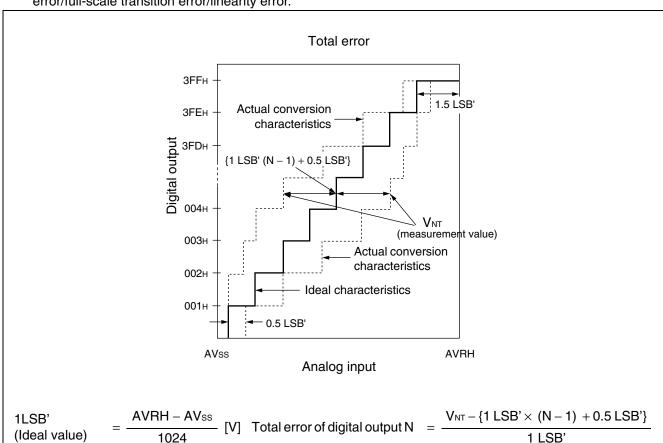
<sup>\*2 :</sup> Vcc = AVcc = 5.0 V, machine clock at 33 MHz

<sup>\*3:</sup> The current when the CPU is in stop mode and the A/D converter is not operating (at Vcc = AVcc = AVRHn = 5.0 V)

<sup>\*4:</sup> AVRHn = AVRH1, AVRH2

#### **Definition of A/D Converter Terms**

- Resolution : Analog variation that is recognized by an A/D converter.
- Linearity error: Zero transition point (00 0000 0000 ←→ 00 0000 0001) and full-scale transition point.
   Difference between the line connected (11 1111 1110 ←→ 11 1111 1111) and actual conversion characteristics.
- Differential linearity error: Deviation of input voltage, that is required for changing output code by 1 LSB, from an ideal value.
- Total error: This error indicates the difference between actual and ideal values, including the zero transition error/full-scale transition error/linearity error.



N: A/D converter digital output value

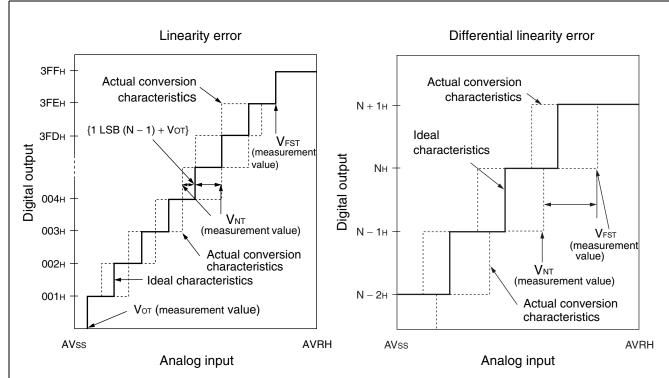
 $V_{NT}$ : A voltage at which digital output transits from (N + 1) to N.

Vot' (Ideal value) = AVss + 0.5LSB' [V]

V<sub>FST</sub>' (Ideal value) = AVRH - 1.5 LSB' [V]

(Continued)





$$\label{eq:linearity} \text{Linearity error in digital output N} \ = \frac{V_{\text{NT}} - \{\ 1\ \text{LSB} \times\ (\text{N}-1)\ + V_{\text{OT}}\ \}}{1\ \text{LSB}} \text{[LSB]}$$

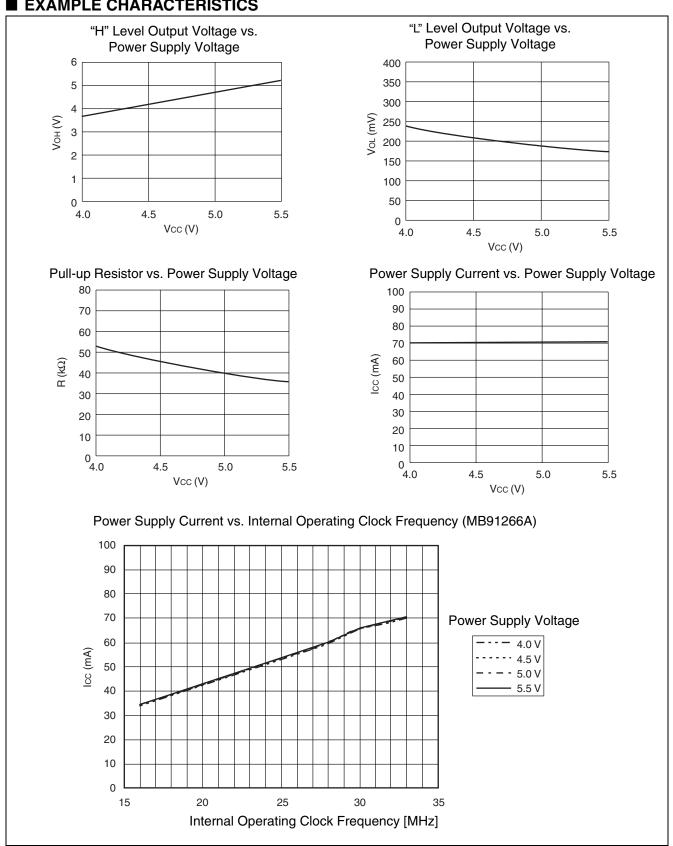
Differential linearity error in digital output N = 
$$\frac{V(N+1)T - V_{NT}}{1 LSB}$$
 - 1 [LSB]

$$1 LSB = \frac{V_{FST} - V_{OT}}{1022} [V]$$

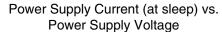
N : A/D converter digital output value

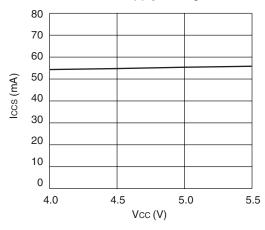
 $V_{\text{OT}}$  : A voltage at which digital output transits from 000H to 001H.  $V_{\text{FST}}$  : A voltage at which digital output transits from 3FEH to 3FFH .

#### **■ EXAMPLE CHARACTERISTICS**

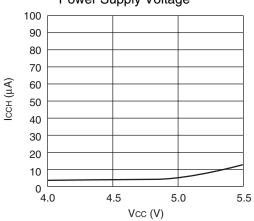


#### (Continued)

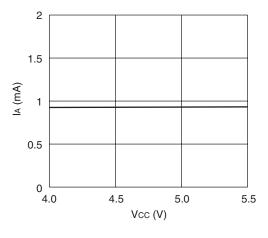




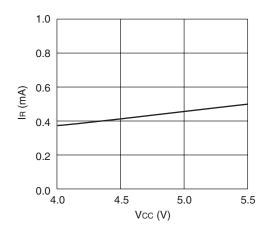
# Power Supply Current (at stop) vs. Power Supply Voltage



A/D Conversion Block Per 1 Unit (33 MHz)
Analog Power Supply Current vs.
Power Supply Voltage



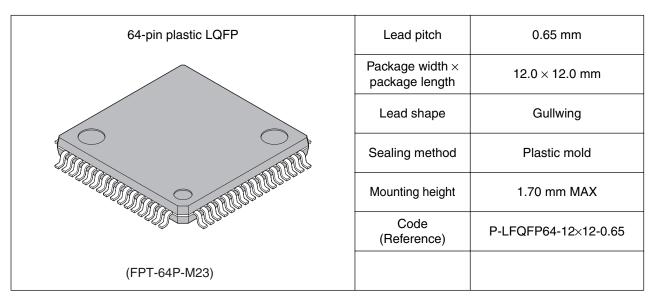
A/D Conversion Block Per 1 Unit (33 MHz)
Reference Power Supply Current vs.
Power Supply Voltage

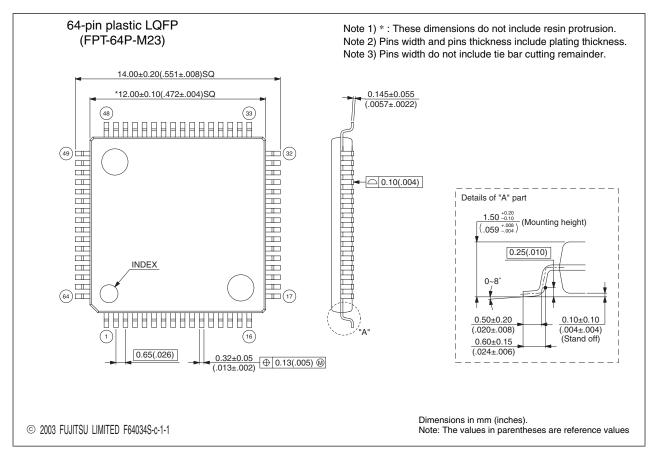


#### **■** ORDERING INFORMATION

Part number	Package	Remarks
MB91266APMC-G-XXX		
MB91266APMC-GS-XXX		
MB91266APMC-G-XXXE1		Lead-free Package
MB91266APMC-GS-XXXE1		Lead-free Package
MB91F267APMC-G		
MB91F267APMC-GS		
MB91F267APMC-GE1	64-pin plastic LQFP	Lead-free Package
MB91F267APMC-GSE1	(FPT-64P-M23)	Lead-free Package
MB91F267NAPMC-G		Package loaded C-CAN
MB91F267NAPMC-GS		Package loaded C-CAN
MB91F267NAPMC-GE1	_	Lead-free Package, Package loaded C-CAN
MB91F267NAPMC-GSE1		Lead-free Package, Package loaded C-CAN
MB91V265ACR-ES	401-pin ceramic PGA (PGA-401C-A02)	

#### **■ PACKAGE DIMENSION**





Please confirm the latest Package dimension by following URL. http://edevice.fujitsu.com/fj/DATASHEET/ef-ovpklv.html

## ■ MAIN CHANGES IN THIS EDITION

Page	Section	Change Results
_	_	Changed the name of the series as follows: MB91265 Series → MB91265A Series
_	_	Added the following part numbers: MB91V265A: evaluation product
8	■ PIN DESCRIPTION	Changed the description of the function of the X0 pin as follows: Clock (oscillation) output terminal.  → Clock (oscillation) input terminal.
		Changed the description of the function of the X1 pin as follows: Clock (oscillation) input terminal.  → Clock (oscillation) output terminal.
14	■ HANDLING DEVICES	Removed the X0A pin and the X1A pin from the description of the crystal oscillator circuit.
47	■ ELECTRICAL CHARACTERISTICS 6. Electrical Characteristics for the A/D Converter	Changed the units of the zero transition voltage and the full transition voltage as follows: LSB $\rightarrow$ V
52	■ ORDERING INFORMATION	Added the following part numbers: MB91V265ACR-ES

The vertical lines marked in the left side of the page show the changes.

The information for microcontroller supports is shown in the following homepage. http://www.fujitsu.com/global/services/microelectronics/product/micom/support/index.html

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